



HIT562

Silicon PNP Epitaxial

REJ03G1503-0200

Rev.2.00

Mar 05, 2007

Features

- Low frequency power amplifier
- Complementary pair with HIT468

Outline

RENESAS Package code: PRSS0003DC-A
(Package name: TO-92 Mod)



1. Emitter
2. Collector
3. Base

Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	-45	V
Collector to emitter voltage	V_{CEO}	-25	V
Emitter to base voltage	V_{EBO}	-6	V
Collector current	I_C	-1.0	A
Collector peak current	$I_{C (peak)}^{*1}$	-1.5	A
Collector power dissipation	P_C	0.8	W
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-55 to +150	°C

Note : 1. PW ≤ 10 ms, Duty cycle ≤ 20%

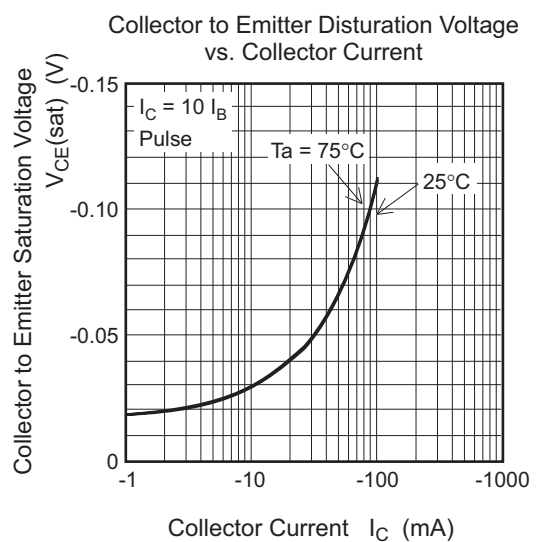
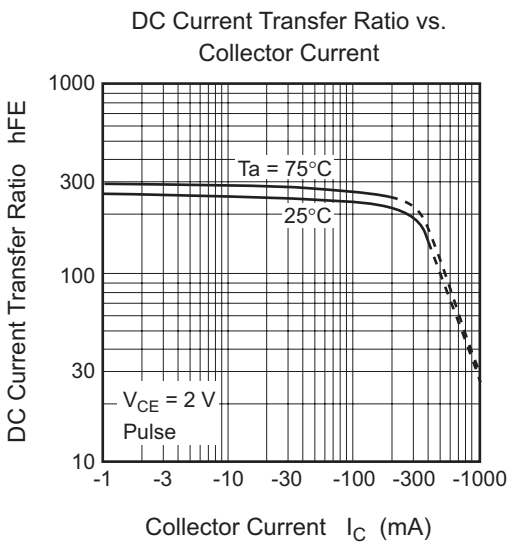
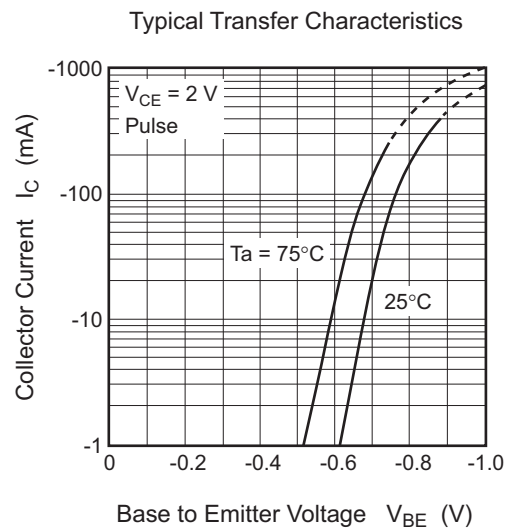
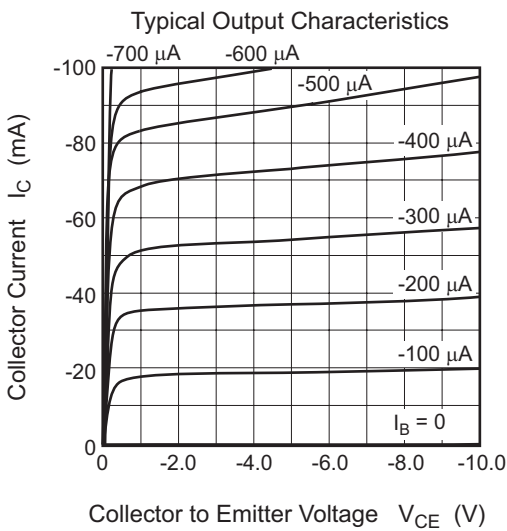
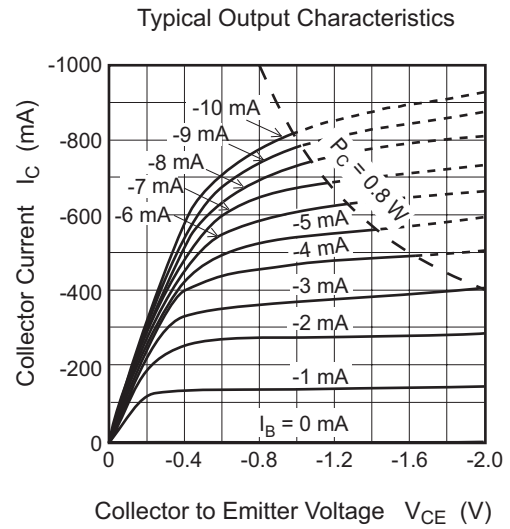
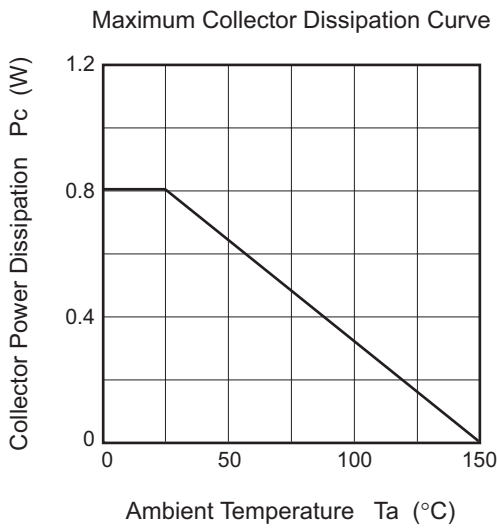


Electrical Characteristics

(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	-45	—	—	V	$I_C = -10 \mu A, I_E = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	-25	—	—	V	$I_C = -100 \mu A, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	-6	—	—	V	$I_E = -10 \mu A, I_C = 0$
Collector cutoff current	I_{CBO}	—	—	-500	nA	$V_{CB} = -45 V, I_E = 0$
Emitter cutoff current	I_{EBO}	—	—	-500	nA	$V_{EB} = -6 V, I_C = 0$
DC current transfer ratio	h_{FE1}	45	—	—	—	$V_{CE} = -1 V, I_C = -5 mA$
	h_{FE2}	85	—	330	—	$V_{CE} = -1 V, I_C = -100 mA$
	h_{FE3}	40	—	—	—	$V_{CE} = -1 V, I_C = -800 mA$
Collector to emitter saturation voltage	$V_{CE(sat)}$	—	—	-0.5	V	$I_C = -800 mA, I_B = -80 mA$
Base to emitter voltage	V_{BE}	—	—	-1	V	$V_{CE} = -1 V, I_C = -10 mA$
Base to emitter saturation voltage	$V_{BE(sat)}$	—	—	-1.2	V	$I_C = -800 mA, I_B = -80 mA$

Main Characteristics



Notes:

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